

# 150 W water pump reference design with SiP

## Product overview

Z8F80905577

## About this document

### Design overview

The reference design guide describes the 150 W Water Pump Reference Design with SiP using the TLE9954QSW40-33 MOTIX™ MCU System in package (SiP). The 3-phase bridge driver TLE9954QSW40-33 is used for automotive motor control for example auxiliary pumps and fans in thermal management systems. The reference design is designed to drive 150 W loads at a battery voltage of 12 V.

The guide includes the schematics of the design, electrical, thermal, and *electromagnetic compatibility (EMC)* measurements according to the CISPR25 standard.

### Highlighted components

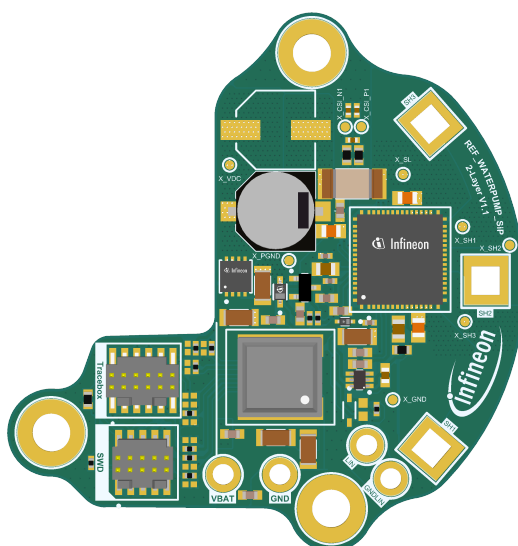
1. MOTIX™ MCU TLE9954QSW40-33
2. OptiMOS™ 7 IAUZN04S7N026

### Applications

- Auxiliary water pump
- Oil pump

### Highlighted design aspects

- Space optimization
- Cost optimization
- EMC optimization
- Thermal optimization



**Figure 1** Reference design

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### 1 System offerings

## 1 System offerings

Infineon's system offering for automotive water pumps with TLE9954QSW40-33 System-in-Package device encompasses a range of components that work together to provide a comprehensive solution.

### Key Components:

- **TLE9954QSW40-33 DUT board:** A robust hardware foundation for efficient integration with a MOTIX™ MCU TLE9954QSW40-33, a OptiMOS™ 7 MOSFET, on board debugger, and several other interfaces
- **REF\_WATERPUMP\_SiP:** An optimized [printed circuit board \(PCB\)](#) for size, thermal and [EMC](#) performance. It highlights the size and PCB cost improvements against a traditional gate driver with discrete MOSFETs
- **REF\_MINI\_CMFRT\_SiP:** Compact automotive solution with Infineon's fully integrated System-in-Package, optimized for minimal PCB size, and faster time-to-market
- **MOTIX™ TLE994\_5x SDK Evaluation edition:** Evaluation edition of Software Development Kit (SDK) for MOTIX™ TLE994x and 995x including Peripheral Driver Library (PDL), Code examples, and Device Configurator settings. CMSIS Pack file
- **Infineon Automotive Power Explorer:** The Infineon Automotive Power Explorer is a powerful tool designed to provide a comprehensive and detailed analysis of Infineon products, enabling users to make informed decisions and optimize their designs. It offers a range of analysis features that enable users to evaluate and compare the performance of different products under various operating conditions
- **MOTIX™ MCU Solution Designer** The MOTIX™ MCU Solution Designer is a graphical configuration tool to analyze, debug, and tune your motor control application. The intuitive [graphical user interface \(GUI\)](#) helps to develop a field-oriented motor control application based on Infineon's MOTIX™ MCU families

## 2 Two reference designs for two different purposes with MOTIX™ MCU TLE9954QSW4...

### 2 Two reference designs for two different purposes with MOTIX™ MCU TLE9954QSW40-33

There are two reference designs for TLE9954QSW40-33 in the list above. Both reference designs are designed very differently and serve very different purposes.

#### 2.1 Value of moving from discrete MOSFETs to System-in-Package

The REF\_WATERPUMP\_SiP was designed as a 1 to 1 replacement for the REF\_WATERPUMP150W. The REF\_WATERPUMP150W uses the traditional architecture with MOTIX™ MCU TLE995x and OptiMOS™ 7 integrated half-bridge MOSFETs. The integration of the MOSFETs allows for different improvements on the [PCB](#) listed below:

- **Reduction of PCB area by 40%:** Both PCBs were designed for the identical water pump and identical feature set. On the REF\_WATERPUMP\_SiP, the unused PCB space was cut away to show the saving in PCB area which resulted in a 40% reduction in PCB area. At the same time, both reference designs are capable of driving 150 W of continuous power
- **Simplification of 4 layer PCB down to 2 layer PCB:** The easier layout of the REF\_WATERPUMP\_SiP allows a good PCB layout on only 2 layers. This results in a cheaper PCB
- **Simplified layout:** As the routing in the commutation path is already integrated in the package of the System-in-Package, the layout gets much easier. First-time-right design with optimized [EMC](#) performance can be achieved due to low parasitic inductance

Below figure shows both REF\_WATERPUMP150W (left) and REF\_WATERPUMP\_SiP (right) side by side

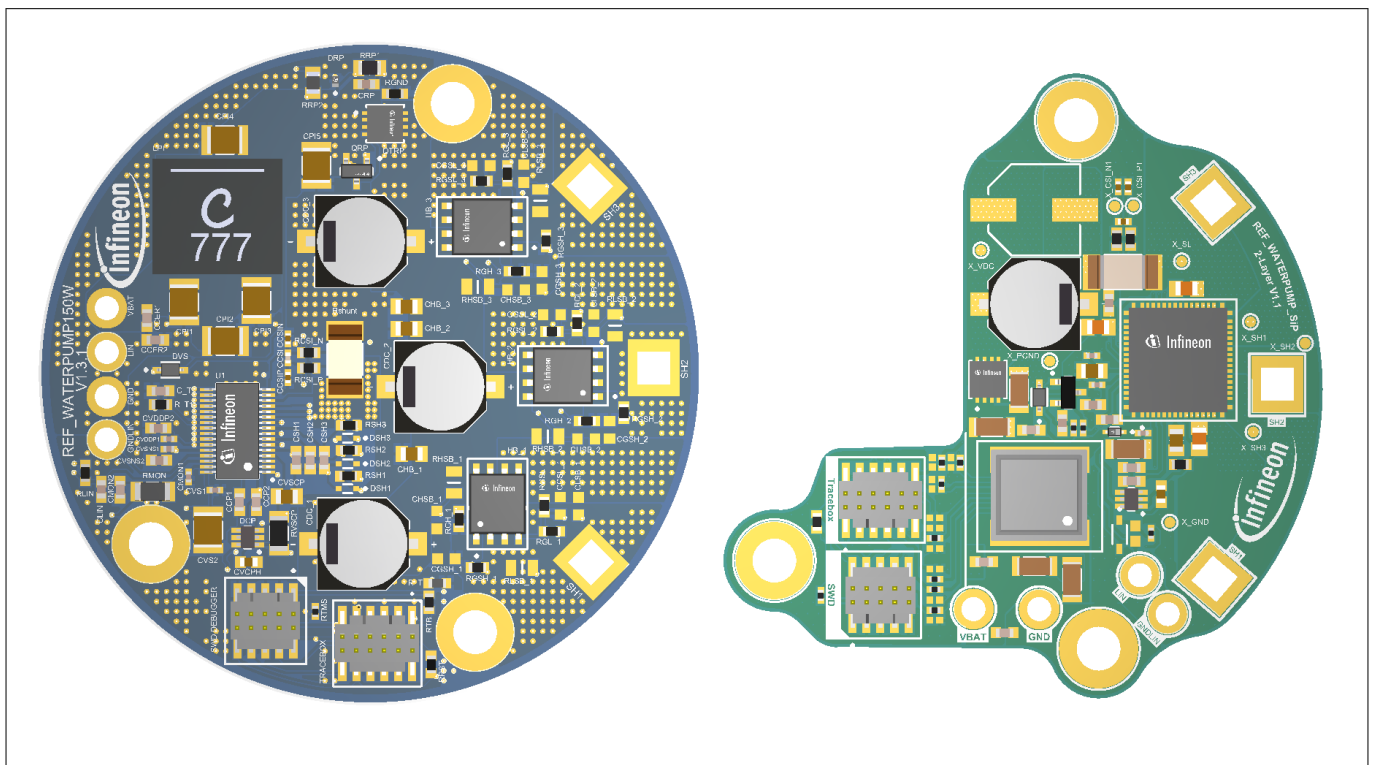


Figure 2 Comparison of REF\_WATERPUMP150W (left) and REF\_WATERPUMP\_SiP (right)

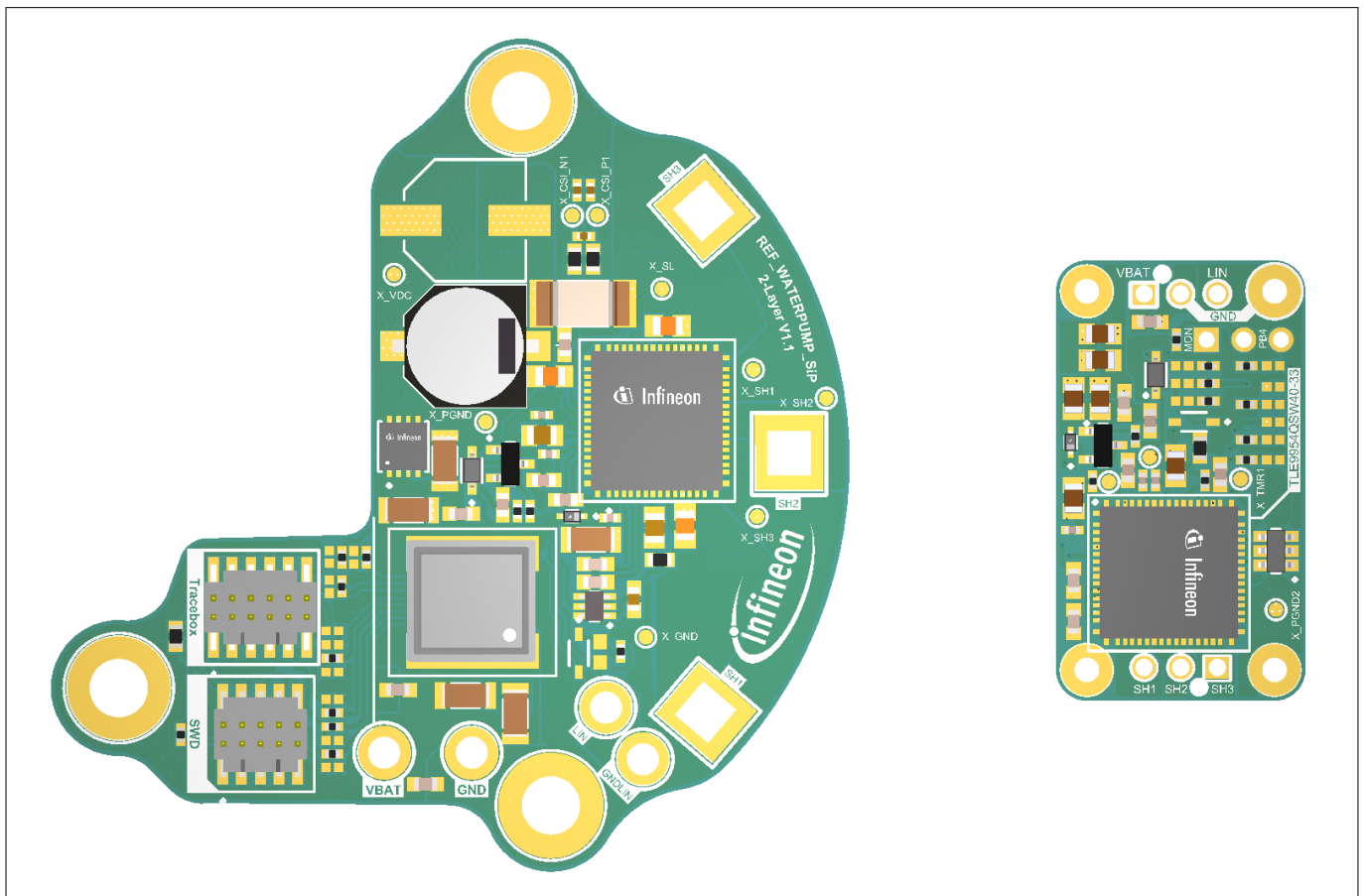
2 Two reference designs for two different purposes with MOTIX™ MCU TLE9954QSW4...

## 2.2 Utilizing MOTIX™ MCU TLE9954QSW40-33 for extremely space constraint environments in comfort applications

### Utilizing MOTIX™ MCU TLE9954QSW40-33 for extremely space constraint environments in comfort applications

The REF\_MINI\_CMFR\_T\_SiP was designed to reduce the *PCB* size as much as possible. To achieve this small size of 30 mm x 17 mm, a double-sided assembly on a 4-layer board was utilized. The device is cooled via the topside of the mold compound of the MOTIX™ MCU TLE9954QSW40-33.

The figure below shows the REF\_WATERPUMP\_SiP (left) next to the REF\_MINI\_CMFR\_T\_SiP (right) in correct relative scale.



**Figure 3** Comparison of REF\_WATERPUMP\_SiP (left) and REF\_MINI\_CMFR\_T\_SiP(right)

To reduce the power losses even further, this design does not use a shunt resistor for current sensing. Instead the XENSIV™ TLE5572 *tunnel magnetoresistance (TMR)* current sensor is used to measure the current flowing through the copper planes inside the PCB is used.

For more details on the REF\_MINI\_CMFR\_T\_SiP, refer to the board user guide of REF\_MINI\_CMFR\_T\_SiP.

## 2.3 Key takeaway

Both *PCB* size and reduction in layers have a positive impact on the total costs of the PCB. This user guide shows that the impact of reduction of PCB size and number of layers on performance is very small and therefore the REF\_WATERPUMP\_SiP can be used in the same applications with tighter space constraints. Additionally, a simplified layout will result in a faster PCB development.

### 3 In detail: 150 W water pump reference design with SiP

REF\_WATERPUMP\_SIP is a reference design for 150 W water pump applications. The design could also be used as a reference for other *brushless DC motor (BLDC motor)* applications. The board of the reference design is developed using standard *PCB* materials and processes.

The reference design uses MOTIX™ TLE9954QSW40-33 SiP integrated with a B6-bridge. The board has one OptiMOS™ 7 IAUZN04S7N026 MOSFET for reverse polarity protection. The design is supplied with power via the 12 V battery terminal connection. The reference design consists of an input PI filter and supports *local interconnect network (LIN)* communication. Measurement of current flowing through the bridge is possible via single shunt resistor. The flash and debug communication to the microcontroller can be established via the debug connectors.

#### 3.1 Design specifications

The design specifications are related to the assembled components and design considerations. They should not differ from the product datasheet recommendations. In case of deviations, the datasheet values of the products are valid.

**Table 1 Design specifications**

| Parameter                     | Symbol                         | Values |      |         | Unit | Comment                                         |
|-------------------------------|--------------------------------|--------|------|---------|------|-------------------------------------------------|
|                               |                                | Min.   | Typ. | Max.    |      |                                                 |
| System parameters             |                                |        |      |         |      |                                                 |
| Function input voltage        | V <sub>IN</sub>                | 8      | 13.5 | 18      | V    | Specified according to water pump specification |
| Peak input current            | I <sub>IN</sub>                | -      | -    | 20      | A    | Peak current (<10 s)                            |
| Nominal input current         | I <sub>IN</sub>                | -      | 11   | -       | A    | 2000 rpm                                        |
| LIN interface                 | V <sub>BUS</sub>               | -40    | -    | 40      | V    |                                                 |
| Phase voltage 1, 2, 3         | V <sub>SH</sub>                | -8     | -    | 48      | V    |                                                 |
| Thermal                       |                                |        |      |         |      |                                                 |
| Operating temperature         | T <sub>A</sub>                 | -40    | 25   | 125     | °C   | Specified by design                             |
| Electromagnetic compatibility |                                |        |      |         |      |                                                 |
| Conducted emissions           |                                |        |      | Class 5 |      | CISPR25, 150 kHz-108 MHz                        |
| Mechanical specification      |                                |        |      |         |      |                                                 |
| Dimensions PCB                | 54 mm x 57 mm (Width x Length) |        |      |         |      |                                                 |

## 3.2 Highlighted products

### 3.2.1 OptiMOS-7™ 40 V IAUZN04S7N026 MOSFET

A high-current, low  $R_{DS(on)}$  power MOSFET in a 3x3 mm<sup>2</sup> advanced leadless package with a Cu-Clip for low package  $R_{ON}$  and minimal stray inductance, offering high power density, low conduction losses, and optimized switching behavior, with a reduced form factor compared to traditional leaded packages, ideal for automotive applications, for example power distribution, body control modules, and electric motors. For further information, see [IAUZN04S7N026](#).

### 3.2.2 MOTIX™ MCU | 32-bit motor control SiP with integrated 3-phase bridge driver

TLE9954QSW40-33 belongs to the TLE995x family of 32-bit motor control SiPs with integrated 3-phase bridge driver and support for [LIN](#). The potential applications of TLE995x include automotive motor control for auxiliary drives like pumps and fans in thermal management. In addition, [microcontroller unit \(MCU\)](#) system clock frequency supporting a wide range of motor control algorithms, either sensor-based or sensorless. Further information of the product can be found [here](#).

## **Glossary**

### **BLDC motor**

*brushless DC motor (BLDC motor)*

A synchronous motor using a direct current electric power supply.

### **EMC**

*electromagnetic compatibility (EMC)*

The ability of electrical equipment and systems to function acceptably in their electromagnetic environment, by limiting the unintentional generation, propagation and reception of electromagnetic energy which may cause unwanted effects such as electromagnetic interference (EMI) or even physical damage in operational equipment.

### **GUI**

*graphical user interface (GUI)*

An interface that enables users to interact with electronic devices through icons and visual indicators.

### **LIN**

*local interconnect network (LIN)*

### **MCU**

*microcontroller unit (MCU)*

A small computer on a single integrated circuit containing a processor core, memory, and programmable input/output peripherals.

### **PCB**

*printed circuit board (PCB)*

A board that mechanically supports and electrically connects electronic components using conductive tracks, pads, and other features etched from copper sheets laminated onto a non-conductive substrate.

### **TMR**

*tunnel magnetoresistance (TMR)*

A magnetoresistive phenomenon that occurs in a magnetic tunnel junction, used for example, for sensors.

## Revision history

| Document version | Date of release | Description of changes                                                   |
|------------------|-----------------|--------------------------------------------------------------------------|
| Rev. 1.00        | 2026-02-27      | <ul style="list-style-type: none"><li>Initial document release</li></ul> |

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